# Si6955DQ

FAIRCHILD SEMICONDUCTOF

## Dual 30V P-Channel PowerTrench<sup>®</sup> MOSFET

## **General Description**

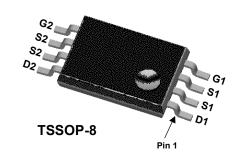
This P-Channel MOSFET is a rugged gate version of Fairchild's Semiconductor's advanced PowerTrench process. It has been optimized for power management applications requiring a wide range of gate drive voltage ratings (4.5V - 20V).

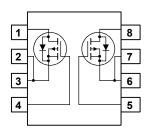
## Applications

- Load switch
- Battery protection
- DC/DC conversion
- Power management

## Features

- Extended  $V_{\text{GSS}}$  range (±20V) for battery applications
- Low gate charge
- + High performance trench technology for extremely low  $R_{\text{DS}(\text{ON})}$
- Low profile TSSOP-8 package





## Absolute Maximum Ratings T<sub>A</sub>=25°C unless otherwise noted

Symbol	Parameter			Ratings Un		
V <sub>DSS</sub>	Drain-Sour	ce Voltage		-30		
V <sub>GSS</sub>	Gate-Source Voltage			±20	V	
ID	Drain Curre	ent – Continuous	(Note 1)	-2.5	A	
		<ul> <li>Pulsed</li> </ul>		-20		
P <sub>D</sub>	Power Diss	sipation for Single Operation	ON (Note 1a)	1.0	W	
			(Note 1b)	0.6		
T <sub>J</sub> , T <sub>STG</sub>	Operating and Storage Junction Temperature Range			-55 to +150		
Therma	l Charac	teristics				
$R_{\theta J A}$	Thermal R	esistance, Junction-to-Aml	bient (Note 1a)	100	°C/W	
			(Note 1b)	125		
Packag	e Markir	ng and Ordering	Information		<u>.</u>	
Device Marking		Device	Reel Size	Tape width	Quantity	
6955		Si6955DQ	13"	12mm	2500 units	

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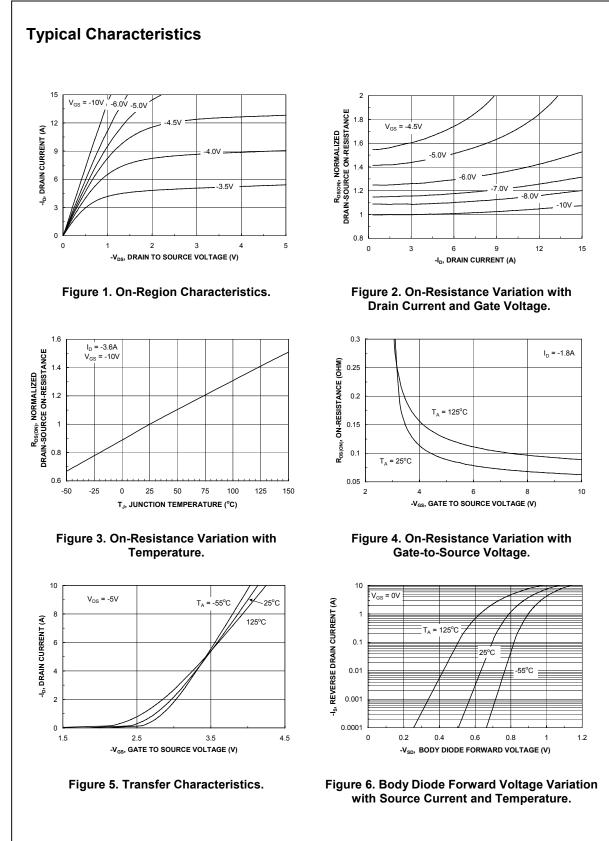
Si6955DQ Rev C(W)

Si6955DQ

teristics Drain–Source Breakdown Voltage Breakdown Voltage Temperature Coefficient	$V_{GS} = 0 V, I_D = -250 \mu A$	-30	·		
Drain–Source Breakdown Voltage Breakdown Voltage Temperature		-30			
					V
Juenicient	$I_D$ = –250 µA, Referenced to 25°C		-22		mV/°C
Zero Gate Voltage Drain Current	V <sub>DS</sub> = -24 V, V <sub>GS</sub> = 0 V			–1	μA
Gate–Body Leakage, Forward	$V_{GS} = -20 V$ , $V_{DS} = 0 V$			-100	nA
Sate-Body Leakage, Reverse	V <sub>GS</sub> = 20 V, V <sub>DS</sub> = 0 V			100	nA
teristics (Note 2)					
Gate Threshold Voltage	$V_{DS} = V_{GS}, I_{D} = -250 \ \mu A$	-1	-1.9	-3	V
Sate Threshold Voltage Temperature Coefficient	$I_{\rm D}$ = –250 $\mu A,$ Referenced to 25°C		4		mV/°C
Static Drain–Source Dn–Resistance	$V_{GS} = -4.5 \text{ V},  I_{D} = -1.8 \text{ A}$		64 101 96	85 190 128	mΩ
Dn-State Drain Current	$V_{GS} = -10 \text{ V},  V_{DS} = -5 \text{ V}$	–15			А
Forward Transconductance	$V_{DS} = -10V$ , $I_D = -2.5 A$		6		S
Characteristics					
			298		pF
	50 / 60 /		83		pF
	t = 1.0 MHz		39		pF
	$V_{DD} = -15 V$ , $I_D = -1 A$ ,		6	15	ns
,	$V_{GS} = -10 \text{ V},  R_{GEN} = 6 \Omega$		-		ns
			-	-	ns
					ns
	$V_{DS} = -10V$ , $I_D = -2.5 A$ ,		-	-	nC
-	$V_{GS} = -10 V$		-		nC
-					nC
Ũ	and Maximum Datings				
				-0.83	А
Drain–Source Diode Forward			-0.8	-1.2	V
	iate-Body Leakage, Reverse         iate-Body Leakage, Reverse         iate-Body Leakage, Reverse         iate Threshold Voltage         iate Threshold Voltage         emperature Coefficient         tatic Drain-Source         in-Resistance         in-State Drain Current         orward Transconductance         Characteristics         input Capacitance         input Capacitance	Sate-Body Leakage, Reverse $V_{GS} = 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Sate-Body Leakage, Reverse $V_{GS} = 20 \text{ V}$ , $V_{DS} = 0 \text{ V}$ Sate Threshold Voltage $V_{DS} = V_{GS}, I_D = -250 \mu \text{A}$ Sate Threshold Voltage $I_D = -250 \mu \text{A}$ , Referenced to $25^{\circ}\text{C}$ Sate Threshold Voltage $I_D = -2.5 \text{ A}$ Sate Threshold Voltage $V_{GS} = -10 \text{ V}$ , $I_D = -2.5 \text{ A}$ Sate Threshold Voltage $V_{GS} = -10 \text{ V}$ , $I_D = -2.5 \text{ A}$ Sate Threshold Voltage $V_{GS} = -10 \text{ V}$ , $V_{DS} = -5 \text{ V}$ Som-Resistance $V_{DS} = -10 \text{ V}$ , $V_{DS} = 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100teristics (Note 2)sate Threshold Voltage $V_{DS} = V_{GS}$ , $I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ 4ate Threshold Voltage $I_D = -250 \ \mu\text{A}$ , Referenced to $25^{\circ}\text{C}$ 4emperature Coefficienttatic Drain-Source $V_{GS} = -10 \ V$ , $I_D = -2.5 \ A$ , $I_D = -1.8 \ A$ 101190V_{GS} = -10 V, $I_D = -2.5 \ A$ , $I_D = 1.25^{\circ}\text{ C}$ 96128on-State Drain Current $V_{GS} = -10 \ V$ , $I_D = -2.5 \ A$ , $I_D = 1.25^{\circ}\text{ C}$ 96128onward Transconductance $V_{DS} = -10 \ V$ , $I_D = -2.5 \ A$ 60Characteristicsput CapacitanceV_{DS} = -10 V, $V_{DS} = 0 \ V$ , $f = 1.0 \ MHz$ 83convert of the transfer CapacitanceV_{DS} = -10 V, $V_{GS} = 0 \ V$ , $f = 1.0 \ MHz$ 83convert of the transfer CapacitanceUm-On Delay TimeUm-On Delay TimeUm-Off Fall TimeOff Sate-Source ChargeIntervence ChargeSate -10 V, $V_{GS} = 0 \ V$ , $R_{GEN} = 6 \ \Omega$ Intervence ChargeUn-On Delay TimeUn-Off Fall TimeIntervence ChargeIntervence ChargeIntervence 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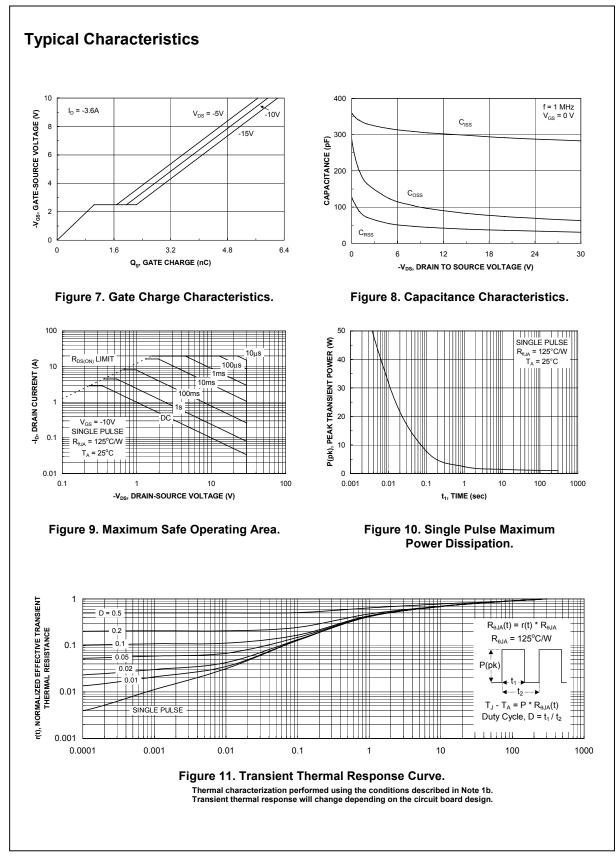
Scale 1 : 1 on letter size paper 2. Pulse Test: Pulse Width < 300µs, Duty Cycle < 2.0%

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